

/ Descriptions

Silicon NPN transistor in a TO-251 Plastic Package.

/ Features

Low $V_{CE(sat)}$, complementary to KTA1040I.

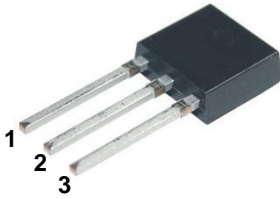
/ Applications

General purpose amplifier for surface mount applications.

/ Equivalent Circuit



/ Pinning



PIN1 Base PIN 2 Collector PIN 3 Emitter

/ h_{FE} Classifications & Marking

h_{FE} Classifications Symbol	Y	GR
h_{FE} Range	100~200	150~300

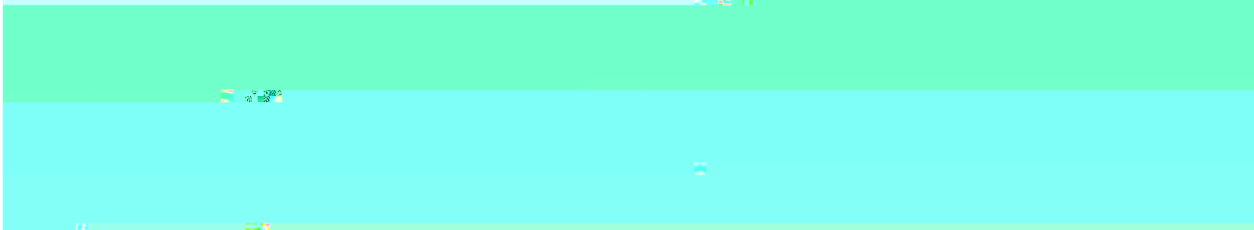
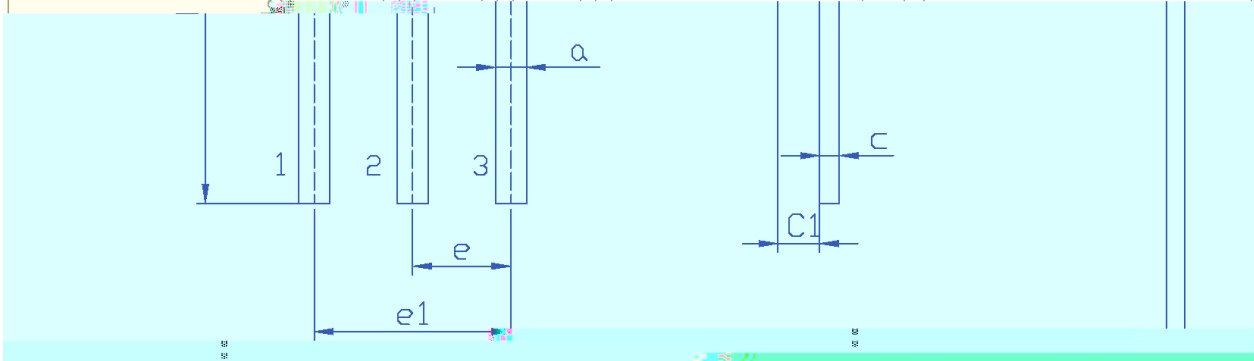
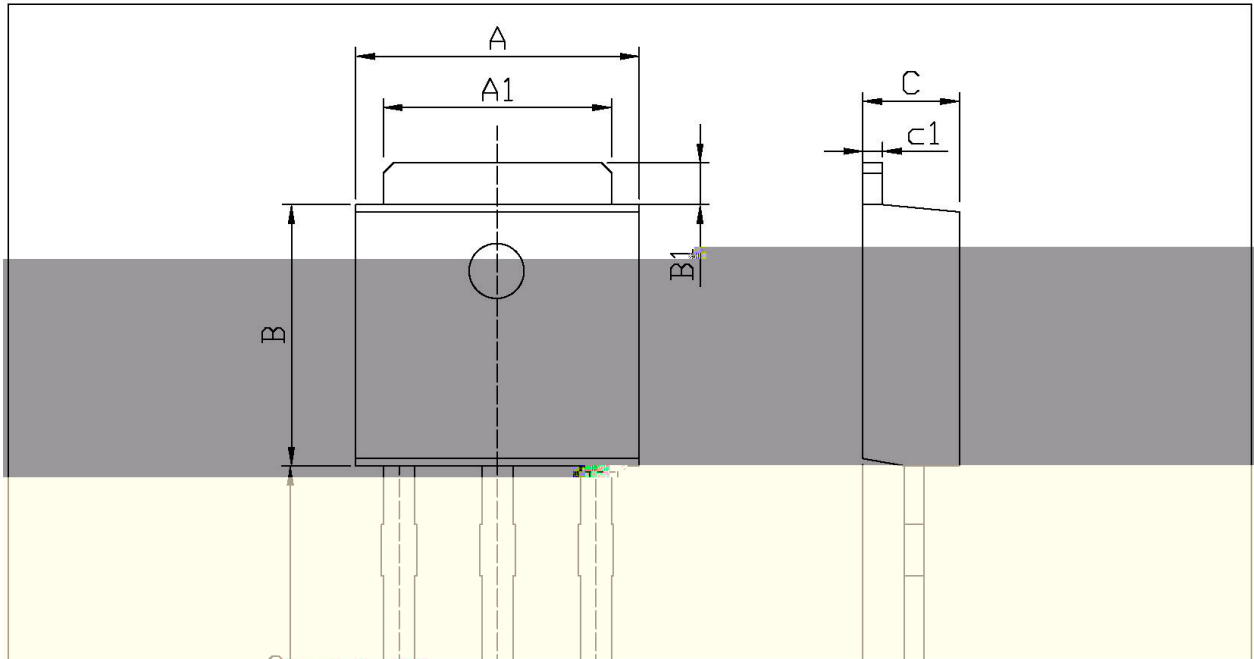
/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	60	V
Collector to Emitter Voltage	V_{CEO}	60	V
Emitter to Base Voltage	V_{EBO}	7.0	V
Collector Current - Continuous	I_C	3.0	A
Base Current - Continuous	I_B	0.5	A
Collector Power Dissipation	P_C	1.0	W
Collector Power Dissipation	$P_C(TC=25)$	20	W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55~150	

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C=50mA$ $I_B=0$	60			V
Collector Cut-Off Current	I_{CBO}	$V_{CB}=60V$ $I_E=0$			100	μA
Emitter Cut-Off Current	I_{EBO}	$V_{EB}=7.0V$ $I_C=0$			100	μA
DC Current Gain	h_{FE}	$V_{CE}=5.0V$ $I_C=0.5A$	100		300	
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=2.0A$ $I_B=0.2A$		0.5	1.0	V
Base to Emitter Voltage	V_{BE}	$V_{CE}=5.0V$ $I_C=0.5A$		0.7	1.0	V
Transition Frequency	f_T	$V_{CE}=5.0V$ $I_C=0.5A$		30		MHz
Collector output capacitance	C_{ob}	$V_{CB}=10V$ $I_E=0$ $f=1.0MHz$		35		pF
Turn-On Time	t_{on}	$10I_{B1}=-10I_{B2}=I_C=2.0A,$ $V_{CC}=30V$		0.65		μs
Storage Time	t_{stg}			1.3		
Fall Time	t_f			0.65		

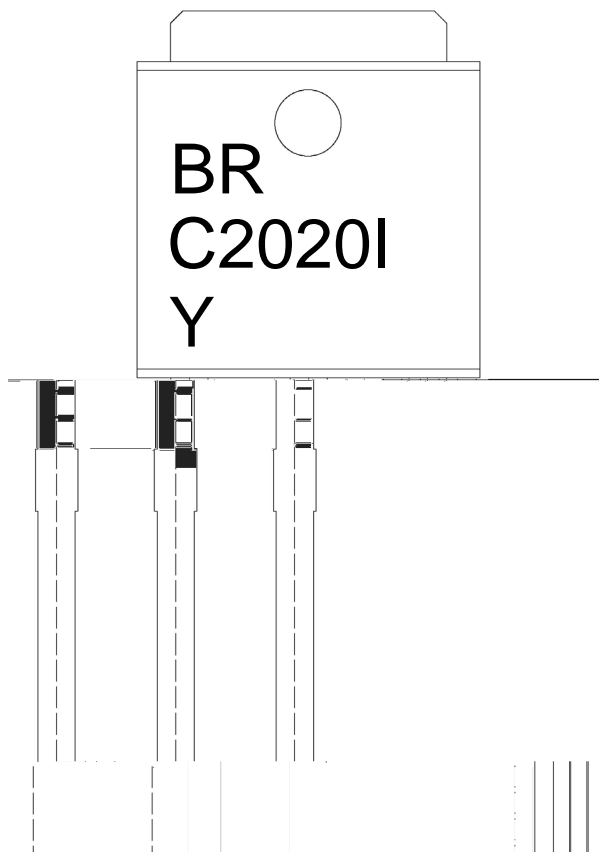
/ Package Dimensions



0.95	1.25	C	0.45	0.55	B
0.95	1.25	$C1$	0.45	0.55	$B1$
2.20	2.40	e	2.24	2.34	C
0.95	1.15	$e1$	4.43	4.73	$C1$

TO-251

/ Marking Instructions



Note:

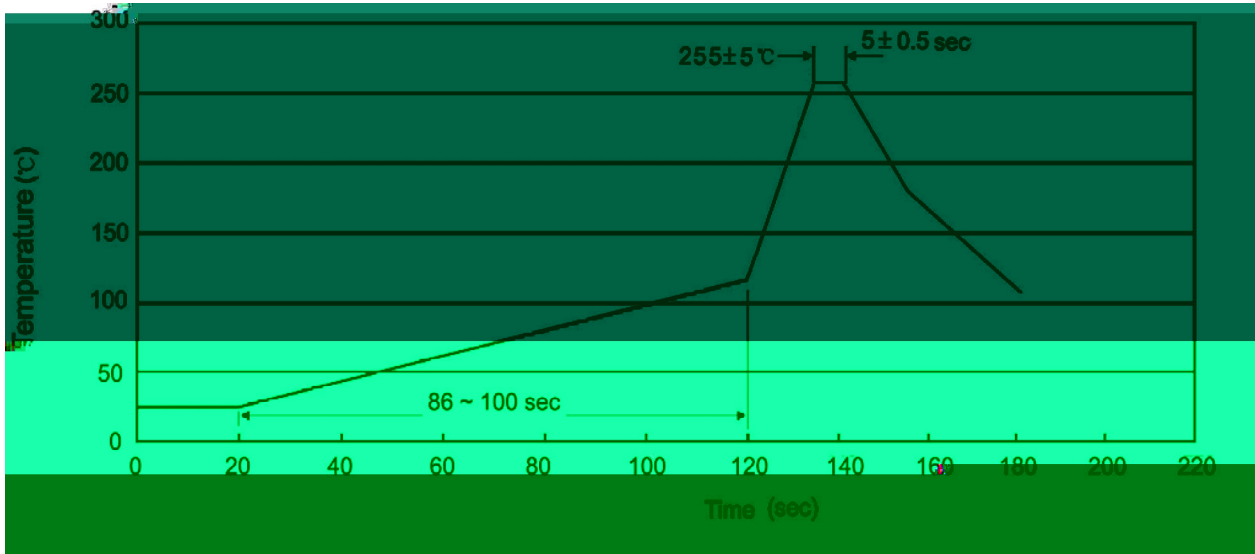
BR: Company Code

C2020I: Product Type.

Y: h_{FE} Classifications Symbol

****: Lot No. Code, code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-----|-----|----|----------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 255 | 5 | 5 | 0.5sec; | 2.Peak Temp.:255 5 , Duration:5 0.5sec. |
| 3 | | | 2 | 10 /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270 5 10 1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

/ BULK

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	只袋	袋盒	只盒	盒箱	只箱	袋	盒	箱

/ TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	只套管	套管盒	只盒	盒箱	只箱	套管	盒	箱

/ Notices